# Features

- Low-voltage and Standard-voltage Operation – 2.7 (V<sub>CC</sub> = 2.7V to 5.5V)
- User Selectable Internal Organization - 16K: 2048 x 8 or 1024 x 16
- 3-wire Serial Interface
- Sequential Read Operation
- Schmitt Trigger, Filtered Inputs for Noise Suppression
- 2 MHz Clock Rate (5V) Compatibility
- Self-timed Write Cycle (10 ms max)
- High Reliability
  - Endurance: 1 Million Write Cycles
  - Data Retention: 100 Years
- Automotive Grade, Extended Temperature and Lead-Free Devices Available
- 8-lead PDIP, 8-lead JEDEC SOIC, and 8-lead TSSOP Packages

# Description

The AT93C86 provides 16384 bits of serial electrically erasable programmable read only memory (EEPROM) organized as 1024 words of 16 bits each when the ORG Pin is connected to  $V_{CC}$  and 2048 words of 8 bits each when it is tied to ground. The device is optimized for use in many industrial and commercial applications where low power and low voltage operations are essential. The AT93C86 is available in space saving 8-lead PDIP, 8-lead JEDEC SOIC and 8-lead TSSOP packages.

The AT93C86 is enabled through the Chip Select pin (CS), and accessed via a 3-wire serial interface consisting of Data Input (DI), Data Output (DO), and Shift Clock (SK).

# **Pin Configurations**

Pin Name	Function
CS	Chip Select
SK	Serial Data Clock
DI	Serial Data Input
DO	Serial Data Output
GND	Ground
VCC	Power Supply
ORG	Internal Organization
DC	Don't Connect

8-lead PDIP CS 🗆 1 SK 🗌 2 7 🗆 DC 6 🗆 ORG DO 🗌 4 5 🗅 GND 8-lead SOIC CS [ 1 8 2 7 SK [ ] DC DI 3 6 ] ORG DO ☐ GND 4 5 8-lead TSSOP CS 8 7 SK [ 6 🗆 ORG DI 3 DO Λ 5 ] GND





# 3-wire Serial EEPROM

16K (2048 x 8 or 1024 x 16)

# AT93C86

Rev. 1237E-SEEPR-01/03



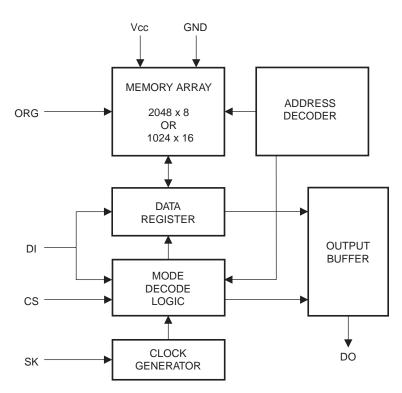
Upon receiving a READ instruction at DI, the address is decoded and the data is clocked out serially on the data output pin DO. The WRITE cycle is completely self-timed and no separate ERASE cycle is required before WRITE. The WRITE cycle is only enabled when the part is in the ERASE/WRITE ENABLE state. When CS is brought "high" following the initiation of a WRITE cycle, the DO pin outputs the READY/BUSY status of the part. The AT93C86 is available in a 2.7V to 5.5V version.

# **Absolute Maximum Ratings\***

Operating Temperature
Storage Temperature
Voltage on any Pin with Respect to Ground1.0V to +7.0V
Maximum Operating Voltage 6.25V
DC Output Current 5.0 mA

\*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability

# **Block Diagram**



Note: 1. When the ORG pin is connected to Vcc, the x 16 organization is selected. When it is connected to ground, the x 8 organization is selected. If the ORG pin is left unconnected and the application does not load the input beyond the capability of the internal 1 Meg ohm pullup, then the x 16 organization is selected. This feature is not available on the 1.8V devices.

# Pin Capacitance<sup>(1)</sup>

Applicable over recommended operating range from  $T_A = 25^{\circ}C$ , f = 1.0 MHz,  $V_{CC} = +5.0V$  (unless otherwise noted).

Symbol	Test Conditions	Max	Units	Conditions
C <sub>OUT</sub>	Output Capacitance (DO)	5	pF	$V_{OUT} = 0V$
C <sub>IN</sub>	Input Capacitance (CS, SK, DI)	5	pF	$V_{IN} = 0V$

Note: 1. This parameter is characterized and is not 100% tested.

# **DC** Characteristics

Applicable over recommended operating range from:  $T_{AI} = -40^{\circ}C$  to  $+85^{\circ}C$ ,  $V_{CC} = +2.7V$  to +5.5V,  $T_{AE} = -40^{\circ}C$  to  $+125^{\circ}C$ ,  $V_{CC} = +2.7V$  to +5.5V (unless otherwise noted).

Symbol	Parameter	Test Condition		Min	Тур	Max	Unit
V <sub>CC1</sub>	Supply Voltage			2.7		5.5	V
V <sub>CC2</sub>	Supply Voltage					5.5	V
1	Supply Current		READ at 1.0 MHz		0.5	2.0	mA
I <sub>CC</sub>	Supply Current	$V_{CC} = 5.0V$	WRITE at 1.0 MHz		0.5	2.0	mA
I <sub>SB1</sub>	Standby Current	$V_{CC} = 2.7V$	CS = 0V		6.0	10.0	μA
I <sub>SB2</sub>	Standby Current	$V_{CC} = 5.0V$	CS = 0V		17	30	μA
I <sub>IL</sub>	Input Leakage	$V_{IN} = 0V$ to $V_{CC}$			0.1	1.0	μA
I <sub>OL</sub>	Output Leakage	$V_{IN} = 0V$ to $V_{CC}$			0.1	1.0	μA
V <sub>IL1</sub> <sup>(1)</sup> V <sub>IH1</sub> <sup>(1)</sup>	Input Low Voltage Input High Voltage	$4.5V \le V_{CC} \le 5.5V$		-0.6 V <sub>CC</sub> x 0.7		V <sub>CC</sub> x 0.3 V <sub>CC</sub> + 1	V
V <sub>IL2</sub> <sup>(1)</sup> V <sub>IH2</sub> <sup>(1)</sup>	Input Low Voltage Input High Voltage	$V_{CC} \le 2.7 V$		-0.6 V <sub>CC</sub> x 0.7		V <sub>CC</sub> x 0.3 V <sub>CC</sub> + 1	V
V <sub>OL1</sub>	Output Low Voltage		I <sub>OL</sub> = 2.1 mA			0.4	V
V <sub>OH1</sub>	Output High Voltage	$4.5V \le V_{CC} \le 5.5V$	I <sub>OH</sub> = -0.4 mA	2.4			V
V <sub>OL2</sub>	Output Low Voltage		I <sub>OL</sub> = 0.15 mA			0.2	V
V <sub>OH2</sub>	Output High Voltage	$V_{CC} \le 2.7V$	I <sub>OH</sub> = -100 μA	V <sub>CC</sub> - 0.2			V

Note: 1.  $V_{IL}$  min and  $V_{IH}$  max are reference only and are not tested.





# **AC Characteristics**

Applicable over recommended operating range from  $T_{AI} = -40^{\circ}C$  to  $+ 85^{\circ}C$ ,  $T_{AE} = -40^{\circ}C$  to  $+ 125^{\circ}C$ ,  $V_{CC} = As$  Specified, CL = 1 TTL Gate and 100 pF (unless otherwise noted).

Symbol	Parameter	Test Condition		Min	Тур	Max	Units
f <sub>SK</sub>	SK Clock Frequency	$\begin{array}{l} 4.5 V \leq V_{CC} \leq 5.5 V \\ 2.7 V \leq V_{CC} \leq 5.5 V \end{array}$		0 0		2 1	MHz
t <sub>SKH</sub>	SK High Time	$\begin{array}{l} 4.5 \text{V} \leq \text{V}_{\text{CC}} \leq 5.5 \text{V} \\ 2.7 \text{V} \leq \text{V}_{\text{CC}} \leq 5.5 \text{V} \end{array}$		250 250			ns
t <sub>SKL</sub>	SK Low Time	$\begin{array}{l} 4.5 \text{V} \leq \text{V}_{\text{CC}} \leq 5.5 \text{V} \\ 2.7 \text{V} \leq \text{V}_{\text{CC}} \leq 5.5 \text{V} \end{array}$		250 250			ns
t <sub>CS</sub>	Minimum CS Low Time	$\begin{array}{l} 4.5 \text{V} \leq \text{V}_{\text{CC}} \leq 5.5 \text{V} \\ 2.7 \text{V} \leq \text{V}_{\text{CC}} \leq 5.5 \text{V} \end{array}$		250 250			ns
t <sub>CSS</sub>	CS Setup Time	Relative to SK	$\begin{array}{l} 4.5 \text{V} \leq \text{V}_{\text{CC}} \leq 5.5 \text{V} \\ 2.7 \text{V} \leq \text{V}_{\text{CC}} \leq 5.5 \text{V} \end{array}$	50 50			ns
t <sub>DIS</sub>	DI Setup Time	Relative to SK	$\begin{array}{l} 4.5 \text{V} \leq \text{V}_{\text{CC}} \leq 5.5 \text{V} \\ 2.7 \text{V} \leq \text{V}_{\text{CC}} \leq 5.5 \text{V} \end{array}$	100 100			ns
t <sub>CSH</sub>	CS Hold Time	Relative to SK		0			ns
t <sub>DIH</sub>	DI Hold Time	Relative to SK	$\begin{array}{l} 4.5 \text{V} \leq \text{V}_{\text{CC}} \ \leq 5.5 \text{V} \\ 2.7 \text{V} \leq \text{V}_{\text{CC}} \ \leq 5.5 \text{V} \end{array}$	100 100			ns
t <sub>PD1</sub>	Output Delay to '1'	AC Test	$\begin{array}{l} 4.5 V \leq V_{CC} \ \leq 5.5 V \\ 2.7 V \leq V_{CC} \ \leq 5.5 V \end{array}$			250 250	ns
t <sub>PD0</sub>	Output Delay to '0'	AC Test	$\begin{array}{l} 4.5 \text{V} \leq \text{V}_{\text{CC}} \ \leq 5.5 \text{V} \\ 2.7 \text{V} \leq \text{V}_{\text{CC}} \ \leq 5.5 \text{V} \end{array}$			250 250	ns
t <sub>SV</sub>	CS to Status Valid	AC Test	$\begin{array}{l} 4.5 \text{V} \leq \text{V}_{\text{CC}} \leq 5.5 \text{V} \\ 2.7 \text{V} \leq \text{V}_{\text{CC}} \leq 5.5 \text{V} \end{array}$			250 250	ns
t <sub>DF</sub>	CS to DO in High Impedance	AC Test CS = V <sub>IL</sub>	$\begin{array}{l} 4.5 \text{V} \leq \text{V}_{\text{CC}} \leq 5.5 \text{V} \\ 2.7 \text{V} \leq \text{V}_{\text{CC}} \leq 5.5 \text{V} \end{array}$			100 100	ns
	Write Ovela Time	·				10	ms
t <sub>WP</sub>	Write Cycle Time		$4.5V \le V_{CC} \le 5.5V$		4		ms
Endurance <sup>(1)</sup>	5.0V, 25°C, Page Mo	de		1M			Write Cycle

Note: 1. This parameter is characterized and is not 100% tested.

AT93C86

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			Add	ress	D	ata	
Instruction	SB	Op Code	x 8	x 16	x 8	x 16	Comments
READ	1	10	A <sub>10</sub> - A <sub>0</sub>	A <sub>9</sub> - A <sub>0</sub>			Reads data stored in memory, at specified address.
EWEN	1	00	11XXXXXXXXX	11XXXXXXXXX			Write enable must precede all programming modes.
ERASE	1	11	A <sub>10</sub> - A <sub>0</sub>	A <sub>9 -</sub> A <sub>0</sub>			Erases memory location A <sub>n</sub> - A <sub>0</sub> .
WRITE	1	01	A <sub>10</sub> - A <sub>0</sub>	A <sub>9</sub> - A <sub>0</sub>	D <sub>7</sub> - D <sub>0</sub>	D <sub>15</sub> - D <sub>0</sub>	Writes memory location $A_n - A_0$ .
ERAL	1	00	10XXXXXXXX	10XXXXXXXX			Erases all memory locations. Valid only at $V_{CC}$ = 4.5V to 5.5V.
WRAL	1	00	01XXXXXXXX	01XXXXXXXX	D <sub>7</sub> - D <sub>0</sub>	D <sub>15</sub> - D <sub>0</sub>	Writes all memory locations. Valid when $V_{CC}$ = 4.5V to 5.5V and Disable Register cleared.
EWDS	1	00	00XXXXXXXX	00XXXXXXXX			Disables all programming instructions.

# Functional Description

The AT93C86 is accessed via a simple and versatile 3-wire serial communication interface. Device operation is controlled by seven instructions issued by the host processor. **A valid instruction starts with a rising edge of CS** and consists of a Start Bit (logic "1") followed by the appropriate Op Code and the desired memory Address location.

**READ (READ):** The Read (READ) instruction contains the Address code for the memory location to be read. After the instruction and address are decoded, data from the selected memory location is available at the serial output pin DO. Output data changes are synchronized with the rising edges of serial clock SK. It should be noted that a dummy bit (logic "0") precedes the 8- or 16-bit data output string.

**ERASE/WRITE (EWEN):** To assure data integrity, the part automatically goes into the Erase/Write Disable (EWDS) state when power is first applied. An Erase/Write Enable (EWEN) instruction must be executed first before any programming instructions can be carried out. Please note that once in the Erase/Write Enable state, programming remains enabled until an Erase/Write Disable (EWDS) instruction is executed or  $V_{CC}$  power is removed from the part.

**ERASE (ERASE):** The Erase (ERASE) instruction programs all bits in the specified memory location to the logical "1" state. The self-timed erase cycle starts once the ERASE instruction and address are decoded. The DO pin outputs the READY/BUSY status of the part if CS is brought high after being kept low for a minimum of 250 ns ( $t_{CS}$ ). A logic "1" at pin DO indicates that the selected memory location has been erased, and the part is ready for another instruction.

**WRITE (WRITE):** The Write (WRITE) instruction contains the 8 or 16 bits of data to be written into the specified memory location. The self-timed programming cycle,  $t_{WP}$ , starts after the last bit of data is received at serial data input pin DI. The DO pin outputs the READY/BUSY status of the part if CS is brought high after being kept low for a minimum of 250 ns ( $t_{CS}$ ). A logic "0" at DO indicates that programming is still in progress. A logic "1" indicates that the memory location at the specified address has been written with the data pattern contained in the instruction and the part is ready for further instructions. A **READY/BUSY status cannot be obtained if the CS is brought high after the end of the self-timed programming cycle, t\_{WP}.** 





**ERASE ALL (ERAL):** The Erase All (ERAL) instruction programs every bit in the memory array to the logic "1" state and is primarily used for testing purposes. The DO pin outputs the READY/BUSY status of the part if CS is brought high after being kept low for a minimum of 250 ns ( $t_{CS}$ ). The ERAL instruction is valid only at  $V_{CC} = 5.0V \pm 10\%$ .

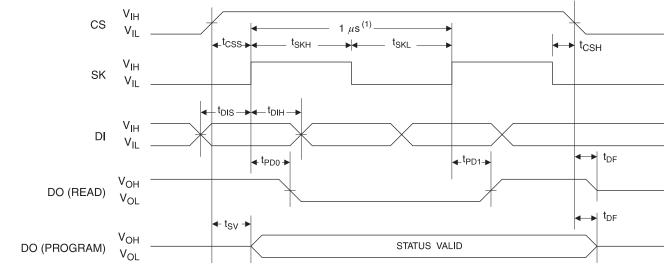
**WRITE ALL (WRAL)**: The Write All (WRAL) instruction programs all memory locations with the data patterns specified in the instruction. The DO pin outputs the READY/BUSY status of the part if CS is brought high after being kept low for a minimum of 250 ns ( $t_{CS}$ ). The WRAL instruction is valid only at  $V_{CC} = 5.0V \pm 10\%$ .

**ERASE/WRITE DISABLE (EWDS):** To protect against accidental data disturb, the Erase/Write Disable (EWDS) instruction disables all programming modes and should be executed after all programming operations. The operation of the READ instruction is independent of both the EWEN and EWDS instructions and can be executed at any time.

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# **Timing Diagrams**

### Synchronous Data Timing



Note: 1. This is the minimum SK period.

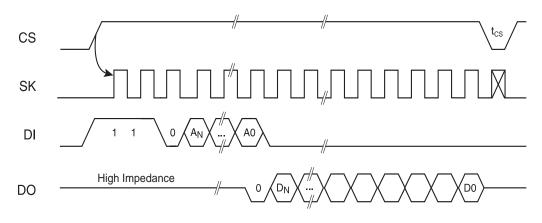
# **Organization Key for Timing Diagrams**

	AT93C86 (16K)		
I/O	x 8	x 16	
A <sub>N</sub>	A <sub>10</sub>	A <sub>9</sub>	
D <sub>N</sub>	D <sub>7</sub>	D <sub>15</sub>	

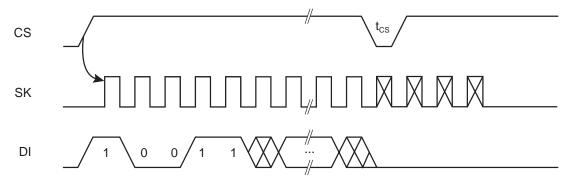




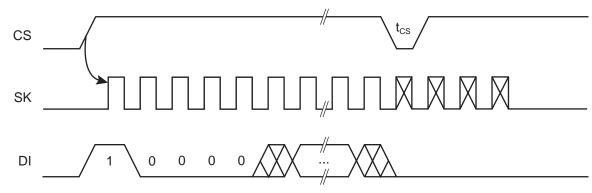
# **READ** Timing



## **EWEN** Timing

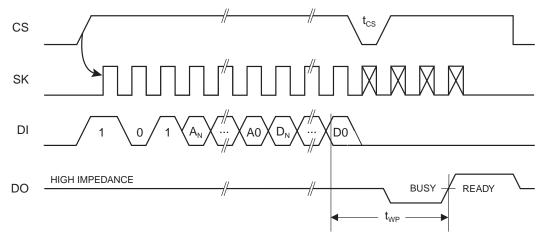


# **EWDS** Timing

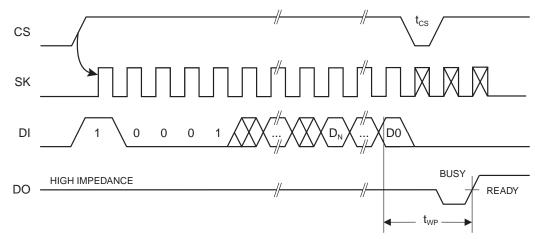


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## WRITE Timing



WRAL Timing<sup>(1)</sup>

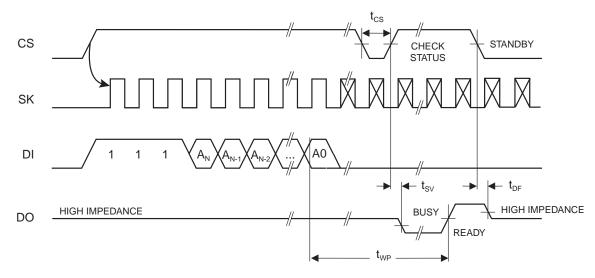


Note: 1. Valid only at  $V_{CC} = 4.5V$  to 5.5V.

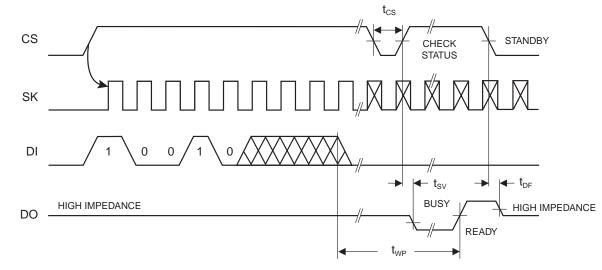




### **ERASE** Timing



# ERAL Timing<sup>(1)</sup>



Note: 1. Valid only at  $V_{CC} = 4.5V$  to 5.5V.

# AT93C86 Ordering Information

Ordering Code	Package	Operation Range
AT93C86-10PI-2.7	8P3	Industrial
AT93C86-10SI-2.7	8S1	(-40°C to 85°C)
AT93C86-10TI-2.7	8A2	
AT93C86-10SJ-2.7	8S1	Lead-Free/Industrial Temperature (-40°C to 85°C)
AT93C86-10SE-2.7	8S1	High Grade/Extended Temperature (-40°C to 125°C)

Note: For 2.7V devices used in a 4.5V to 5.5V range, please refer to performance values in the AC and DC characteristics tables.

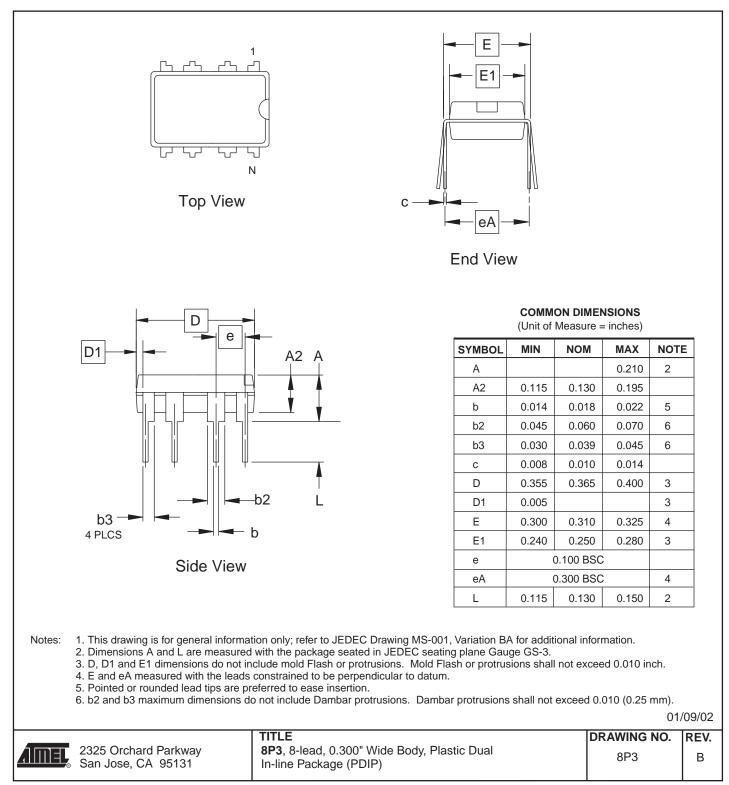
Package Type				
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)			
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)			
8A2	8A2 8-lead, 0.170" Wide, Thin Shrink Small Outline Package (TSSOP)			
	Options			
-2.7	Low Voltage (2.7V to 5.5V)			



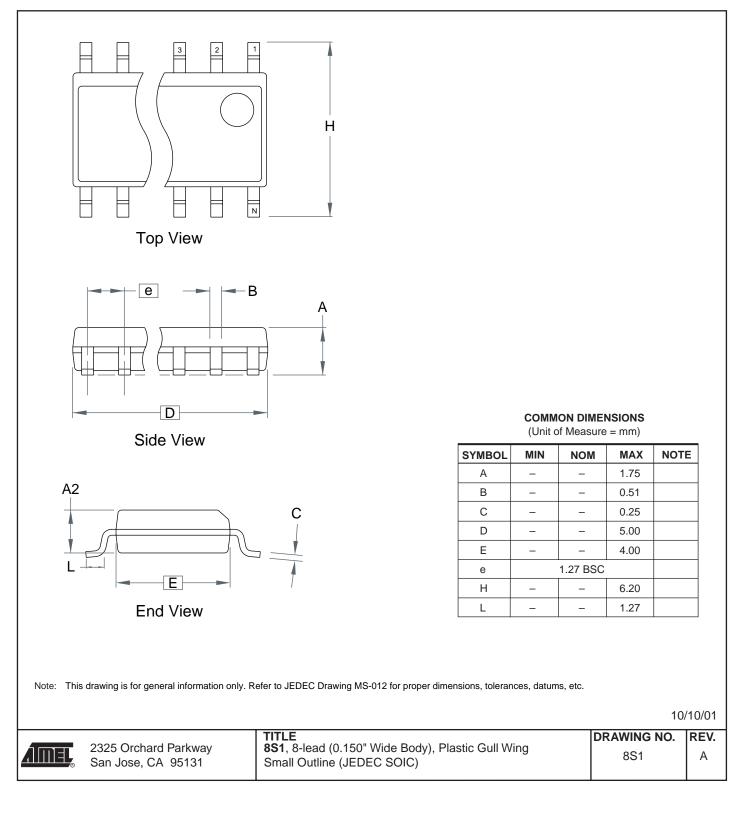


# **Packaging Information**

### 8P3 – PDIP



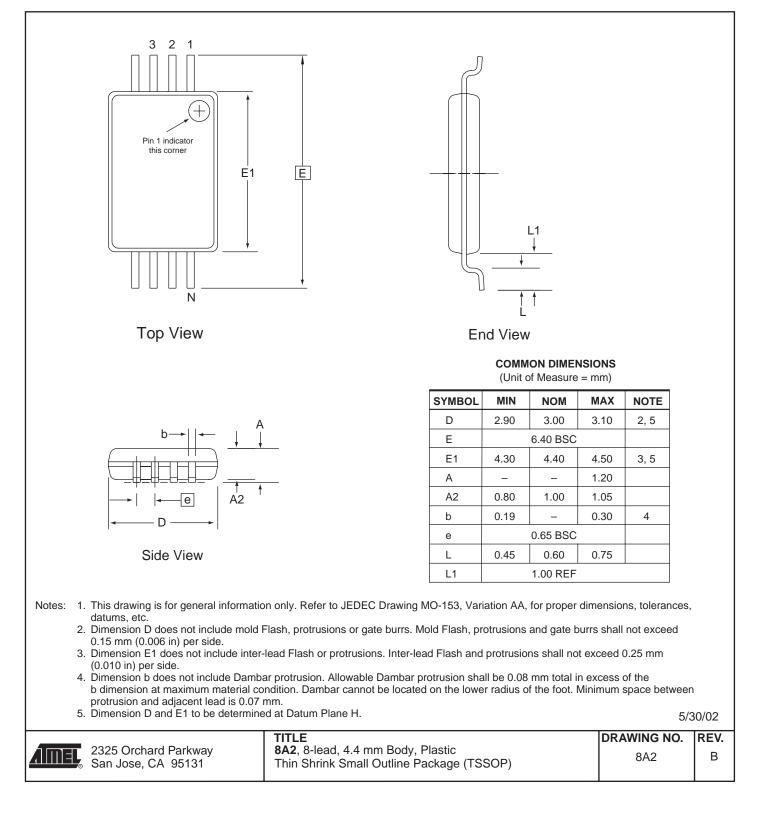
### 8S1 – JEDEC SOIC







### 8A2 – TSSOP





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